

RP400xxx1B SERIES

HIGH EFFICIENCY, SMALL PACKAGES, STEP-UP DC/DC CONVERTERS

NO.EA-193-150909

OUTLINE

RP400xxx1B Series are high efficiency, step-up DC/DC converter ICs packaged in compact 5pin SOT23 or 6pin DFN(PL). This converter starts up of low voltage (Typ.0.7V) operation from one to two alkaline or a nickel-metal-hydride (NiMH) or one-cell Lithium-ion (Li+) battery.

This IC consists of a reference voltage unit with soft start, an error amplifier, phase compensation circuits, a slope circuit, a PWM control circuit, a start-up circuit, a PWM/VFM mode control circuit, internal switches and a protection circuit. As a protection circuit, RP400xxx1B has a current limit circuit which limits the peak current of the inductor at each clock cycle.

A low ripple high efficiency step up DC/DC converter can be composed of RP400xxx1B Series with only an inductor, a diode and capacitors. This converter is based on a fixed frequency current mode PWM control which goes to power save mode (VFM mode) at light load automatically. RP400xxx1B Series has built-in Anti-ringing switch to prevent switching node from ringing, when the converter enters the discontinuous current mode.

The output voltage of RP400K001B can be set within 1.8~5.0V (recommended range of output voltage) by external divider resistors.

FEATURES

| • | Low Start-up Voltage guaranteed ····· | ·0.7V |
|---|---|---|
| • | Input Voltage Range ····· | ·0.7V ~ 5.5V |
| • | High Efficiency ····· | $\cdot 85\%$ (100mA / 3.3V, V _{IN} = 1.5V, 25°C) |
| • | Output current ····· | $\cdot 200$ mA / 3.3V (V _{IN} = 1.5V) Typ.100mA / 2.0V (V _{IN} = 1.2V) |
| • | Internal Switch····· | $\cdot NMOS = 0.4\Omega \text{ (V}_{OUT} = 3.3\text{V}, 25^{\circ}\text{C)}$ |
| • | Built-in Phase Compensation, Soft Start, Peak Cur | rent Limit Protection |
| • | PWM Oscillator Frequency | ·700kHz |
| • | Output Voltage Range | ·Fixed: 1.8V to 5.0V with 0.1V Stepwise Adjustable: 1.8V ~ 5.0V (RP400K001B only) (Recommended range of output voltage) |
| | Stable with Ceramic Capacitors | |
| • | Small Package ····· | · DFN(PL)1820-6, SOT-23-5 |
| _ | | |

APPLICATIONS

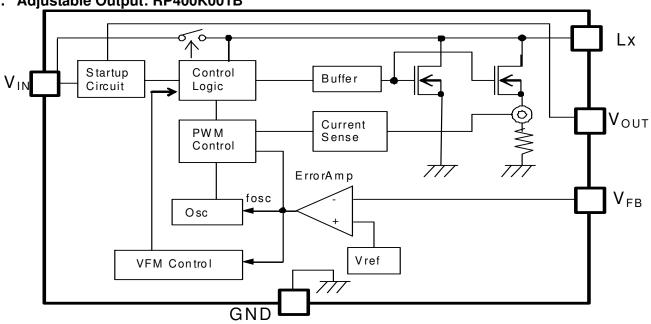
- MP3 players, PDA
- Digital Still Cameras
- LCD Bias Supplies
- Portable blood pressure meter

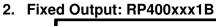
Internal EMI suppression (Anti-ringing switch is included)

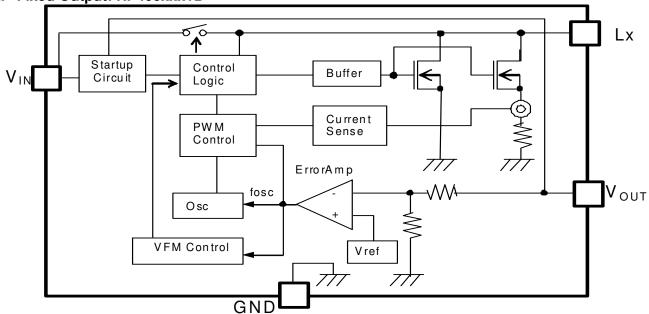
- Wireless Handset
- GPS

BLOCK DIAGRAMS

1. Adjustable Output: RP400K001B







SELECTION GUIDE

In the RP400 Series, output Voltage, Type of Output Voltage, and package for the ICs can be selected at the user's request.

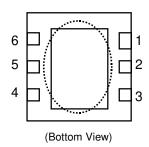
| Product Name | Package | Quantity per Reel | Pb Free | Halogen Free |
|------------------|----------------|-------------------|---------|--------------|
| RP400Kxx1B-TR | DFN (PL)1820-6 | 5,000 pcs | Yes | Yes |
| RP400Nxx1B-TR-FE | SOT-23-5 | 3,000 pcs | Yes | Yes |

xx : Designation of output voltage

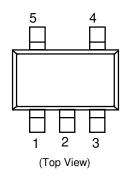
^{00:} Adjustable Version (1.8V \sim 5.0V) * recommended range of output voltage / DFN(PL)1820-6 only Fixed version is possible in the range from 1.8V to 5.0V with a step of 0.1V

PIN CONFIGURATION

DFN(PL)1820-6



SOT-23-5



PIN DESCRIPTION

RP400K001B: DFN(PL)1820-6

| Pin No | Symbol | Pin Description |
|--------|------------------|---|
| 1 | VIN | Power Supply Pin |
| 2 | NC | No Connection |
| 3 | GND | Ground Pin |
| 4 | Lx | Internal NMOS Switch Drain Pin |
| 5 | V _{FB} | Feedback Input Pin for setting output voltage |
| 6 | V _{OUT} | Output Pin |

^{*} Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

RP400Kxx1B: DFN(PL)1820-6

| Pin No | Symbol | Pin Description |
|--------|-----------------|--------------------------------|
| 1 | V _{IN} | Power Supply Pin |
| 2 | NC | No Connection |
| 3 | GND | Ground Pin |
| 4 | Lx | Internal NMOS Switch Drain Pin |
| 5 | NC | No Connection |
| 6 | Vоит | Output Pin |

^{*} Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

RP400Nxx1B: SOT-23-5

| Pin No | Symbol | Pin Description |
|--------|------------------|--------------------------------|
| 1 | NC | No Connection |
| 2 | GND | Ground Pin |
| 3 | V _{IN} | Power Supply Pin |
| 4 | V _{OUT} | Output Pin |
| 5 | Lx | Internal NMOS Switch Drain Pin |

ABSOLUTE MAXIMAM RATINGS

(GND=0V)

| Symbol | Items | Ra | itings | Unit |
|-----------------|--------------------------------|---------------|-------------|-------|
| V _{IN} | V _{IN} Supply Voltage | -0.3 to 6.0 | | V |
| V_{OUT} | V _{OUT} Pin Voltage | -0.3 | -0.3 to 6.0 | |
| V_{LX} | Lx Pin Input Voltage | -0.3 | 3 to 6.0 | V |
| V_{FB} | V _{FB} Pin Voltage | RP400K001B | -0.3 to 6.0 | V |
| I _{LX} | Lx Pin Output Current | | 0.8 | |
| P_{D} | Power Dissipation * | SOT-23-5 | 420 | mW |
| FD | | DFN(PL)1820-6 | 880 | IIIVV |
| Ta | Ambient Temp Range | -40 to + 85 | | °C |
| Tstg | Storage Temp Range | -55 t | o + 125 | °C |

^{*)} For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

(Ta=25°C)

| Symbol | Item | Cond | Conditions | | TYP. | MAX. | Unit |
|--------------------------------|--|--|---|-------|--------------------------|-------|------------|
| VIN | Input Voltage | | | | | 5.5 | ٧ |
| Vstart₁ | Start-up Voltage 1 | Load current =1mA | | | 0.7 | 0.9 | ٧ |
| Vhold₁ | Hold-on Voltage 1 (Once started) | Load current=1mA | | 0.7 | | | ٧ |
| I _{DD1} | Quiescent Current 1 | Adjustable Version | V _{IN} =3V V _{OUT} =5V V _{FB} =0V | | 500 | 800 | μΑ |
| | | Fixed Version. | V_{IN} =0.5× V_{OUT} V_{OUT} = 0.95× V_{OUT} | | V _{OUT} ×100 | (*3) | μΑ |
| I_{DD2} | Quiescent Current 2 | Adjustable Version | V _{IN} =V _{OUT} =5V V _{FB} =1.0V | | 160 | 300 | μΑ |
| V _{FB} | (No switching) | Fixed Version | V _{IN} =V _{OUT} =5V | | 160 | 300 | μΑ |
| V _{FB} | Feedback Voltage (Adjustable Version) | V _{IN} =V _{OUT} =3.3V | | 0.588 | 0.600 | 0.612 | ٧ |
| V _{OUT} | Output-Voltage (Fixed Version) | V _{IN} = 1.5V | | ×0.98 | | ×1.02 | V |
| Δ V ουτ /Δ Ta | Output-Voltage Temperature Coefficient | -40°C≤Ta≤85°C | | | ±100 | | ppm /°C |
| fooo | Switching Frequency | Adjustable Version | V _{IN} =V _{OUT} =3.3V | 595 | 700 | 805 | kHz |
| fosc | | Fixed Version. | V _{IN} =V _{OUT} =0.95×V _{OUT} | 595 | 700 | 805 | kHz |
| ∆fosc /∆Ta | Switching Frequency Temperature Coefficient | -40°C≤Ta≤85°C | | | ±0.2 | | kHz /°C |
| Ronn | NMOS On-Resistance (*1) | V _{OUT} =3.3V | | | 0.4 | | Ω |
| I _{FBH} | FB "H" Input Current (Adjustable Version) | V _{IN} =V _{OUT} =V _{FB} =5V | | | | 0.5 | μΑ |
| I _{XFBL} | FB "L" Input Current (Adjustable Version) | V _{IN} =V _{OUT} =5V V _{FB} =0V | | -0.5 | | | μΑ |
| li | Ly Look Current limit /*?\ | Adjustable Version | V _{OUT} =3.3V Detective at Duty=MaxDuty-5% | 0.4 | 0.6 | | A |
| ILxpeak | Lx Leak Current limit (*2) | Fixed Version. | V _{OUT} = 0.95×V _{OUT} Detective at Duty=MaxDuty-5% | 0.4 | 0.6 | | Α |

ELECTRICAL CHARACTERISTICS (cont.)

(Ta=25°C)

| | | | | | | | / |
|---------|-----------------------------------|--------------------|--|------|-----|------|------|
| Symbol | Item | Co | Conditions | | | MAX. | Unit |
| Maxduty | Max Duty | Adjustable Version | V _{IN} =V _{OUT} =3.3V V _{FB} =0V | 80 | 88 | 95 | % |
| , | | Fixed Version. | VIN=VOUT=0.95×VOUT | 80 | 88 | 95 | % |
| tstart | Soft Start period | Adjustable Version | V _{IN} =0V to 1.65V V _{OUT} =3.3V At V _{OUT} =2.97V | 0.08 | 0.7 | 3.0 | ms |
| | | Fixed Version. | V_{IN} = 0V to $V_{\text{OUT}} \times 0.5$ At V_{OUT} = $V_{\text{OUT}} \times 0.9$ | 0.08 | 0.7 | 3.0 | ms |
| D | Anti-ringing switch On Resistance | Adjustable Version | V _{IN} =V _{OUT} =3.3V | | 110 | | Ω |
| Rona | | Fixed Version. | V _{IN} =V _{OUT} =1.05×V _{OUT} | | 110 | | Ω |

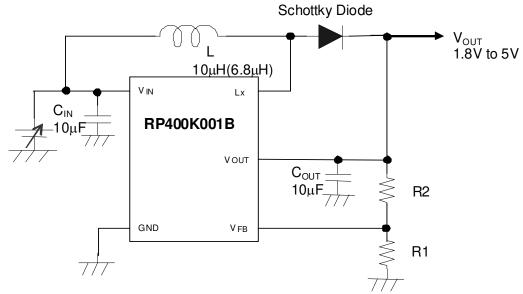
^{*1)} Guaranteed by design engineering. NMOS On-Resistance according to the V_{OUT} voltage.
*2) Lx limit current changes by Duty.
*3) The maximum value of Operating Current 1(Fixed Version) is shown on the table below.

| V _{OUT} (V) | MAX (μA) |
|----------------------|----------|
| 1.8 V | 290 |
| 1.9 V | 310 |
| 2.0 V | 320 |
| 2.1 V | 340 |
| 2.2 V | 360 |
| 2.3 V | 370 |
| 2.4 V | 390 |
| 2.5 V | 400 |
| 2.6 V | 420 |
| 2.7 V | 440 |
| 2.8 V | 450 |
| 2.9 V | 470 |
| 3.0 V | 480 |
| 3.1 V | 500 |
| 3.2 V | 520 |
| 3.3 V | 530 |
| 3.4 V | 550 |

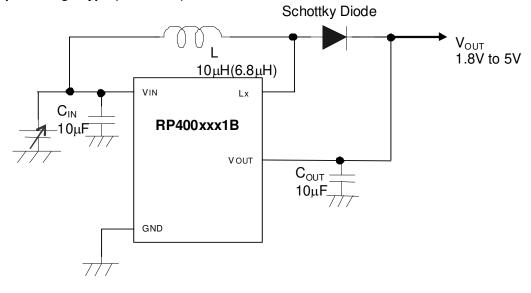
| V _{OUT} (V) | MAX (μA) |
|----------------------|----------|
| 3.5 V | 560 |
| 3.6 V | 580 |
| 3.7 V | 600 |
| 3.8 V | 610 |
| 3.9 V | 630 |
| 4.0 V | 640 |
| 4.1 V | 660 |
| 4.2 V | 680 |
| 4.3 V | 690 |
| 4.4 V | 710 |
| 4.5 V | 720 |
| 4.6 V | 740 |
| 4.7 V | 760 |
| 4.8 V | 770 |
| 4.9 V | 790 |
| 5.0 V | 800 |

APPLICATION NOTES

Adjustable Output Voltage Type (Version:B)



Fixed Output Voltage Type (Version:B)



External components

Capacitor : C2012JB1C106M (TDK)
Diode : CRS10I30A (TOSHIBA)

Inductor: TDK SLF7045T-100M1R3-PF(TDK)

Setting of Output Voltage

Output voltage (1.8V to 5.0V recommended range of voltage) can be set with divider resistors for voltage setting, R1 and R2 as shown in the typical application. Refer to the next formula.

```
Output Voltage = V_{FB} \times (R1 + R2) / R1 (V_{FB} = 0.6V)
Recommended value of resistors (R1 + R2) is lower than 100k\Omega.
```

Make sufficient power supply and ground and reinforce supplying. The large switching current could flow through the connection of power supply, inductor, ground, diode and the connection of V_{OUT}. If the impedance of the connection of power supply and ground is high, the voltage level of power supply of the IC fluctuates with the switching current. We recommend you to use output capacitor and diode with an allowable voltage at least 1.5 times as much as setting output voltage. This is because there may be case where a spike-shaped high voltage is generated by an inductor when built-in transistor is on and off.

Use a diode of a Schottky type with high switching speed, low reverse current and also pay attention to its current capacity.

Set external components as close as possible to the IC and minimize the connection between the components and the IC. In particular, output capacitor should be connected to V_{OUT} pin with IC ground by the minimum connection, because this IC uses the V_{OUT} voltage as the main power supply, after start-up. Use capacitors with a capacity of $10\mu F$ or more for V_{OUT} pin. We recommend you to set a ceramic capacitor ($10\mu F$) between V_{IN} and ground.

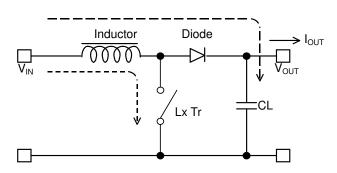
The divider resistors should be placed as close as possible to the IC ground pin. V_{FB} line is recommended to use short line as well to avoid the influence of noise.

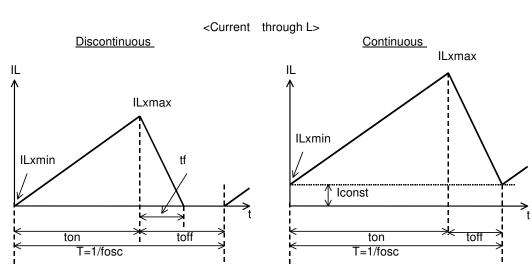
Please select the inductor value $10\mu H$ in the case of $V_{OUT} \ge 2.5 V$ and $6.8\mu H$ in the case of $V_{OUT} < 2.5 V$. Choose an inductor that has sufficiently small D.C. resistance and large allowable current and is hard to reach magnetic saturation. And if the value of inductance of an inductor is extremely small, the I_{LX} may exceed the absolute maximum rating at the maximum loading. Use an inductor with appropriate inductance. (Refer to next Output Current of Step-up Circuit and External Components)

*The performance of power circuit using those ICs extremely depends upon the peripheral circuits. Pay attention in the selection of the peripheral circuits. In particular, design the peripheral circuits in a way that the values such as voltage, current, and power of each component, PCB patterns and the IC do not exceed their respected rated values. (such as the voltage, current, and power)

OUTPUT CURRENT OF STEP-UP CIRCUIT AND EXTERNAL COMPONENTS

<Basic Circuit>





There are two modes, or discontinuous mode and continuous mode for the PWM step-up switching regulator depending on the continuous characteristic of inductor current. During on time of the transistor, when the voltage added on to the inductor is described as V_{IN} , the current is $V_{IN} \times t / L$.

Therefore, the electric power, Pon, which is supplied with input side, can be described as in next formula.

With the step-up circuit, electric power is supplied from power source also during off time. In this case, input current is described as $(V_{OUT} - V_{IN}) \times t / L$, therefore electric power, P_{OFF} is described as in next formula.

$$P_{\text{OFF}} = \int_0^{tf} V_{\text{IN}} \times (V_{\text{OUT}} - V_{\text{IN}}) t/L \ dt \ \cdots \ \text{Formula 2}$$

In this formula, tf means the time of which the energy saved in the inductance is being emitted. Thus average electric power, P_{AV} is described as in the next formula.

$$P_{\text{AV}} = 1/(ton + toff) \times \{ \int_0^{ton} V_{\text{IN}}^2 \times t/L \ dt + \int_0^{tf} V_{\text{IN}} \times (V_{\text{OUT}} - V_{\text{IN}}) t/L \ dt \} \ \cdots$$
 Formula 3

In PWM control, when tf = toff is true, the inductor current becomes continuous, then the operation of switching regulator becomes continuous mode. In the continuous mode, the deviation of the current is equal between on time and off time.

$$V_{IN} \times ton / L = (V_{OUT} - V_{IN}) \times toff / L$$
Formula 4

Further, the electric power, PAV is equal to output electric power, Vout × lout, thus,

$$l_{OUT} = fosc \times V_{IN}^2 \times ton^2 / \{2 \times L (V_{OUT} - V_{IN})\} = V_{IN}^2 \times ton / (2 \times L \times V_{OUT}) \cdots Formula 5$$

When I_{OUT} becomes more than $V_{IN} \times ton \times toff / (2 \times L \times (ton + toff))$, the current flows through the inductor, then the mode becomes continuous. The continuous current through the inductor is described as lconst, then,

$$l_{OUT} = fosc \times V_{IN}^2 \times ton^2 / (2 \times L \times (V_{OUT} - V_{IN})) + V_{IN} \times l_{Const} / V_{OUT} + \cdots Formula 6$$

In this moment, the peak current, ILxmax flowing through the inductor and the driver Tr. is described as follows:

$$ILxmax = Iconst + V_{IN} \times ton / L$$
Formula 7

With the formula 4, 6 and ILxmax is

$$ILxmax = V_{OUT} / V_{IN} \times I_{OUT} + V_{IN} \times ton / (2 \times L) \qquad \cdots$$

$$However, ton = (1 - V_{IN} / V_{OUT}) / fosc$$

Therefore, peak current is more than I_{OUT}. Considering the value of ILxmax, the condition of input and output, and external components should be selected.

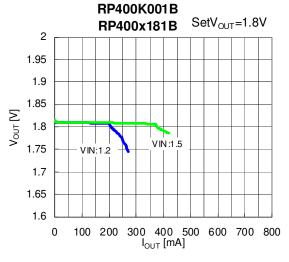
In the formula 7, peak current ILxmax at discontinuous mode can be calculated. Put Iconst = 0 in the formula.

The explanation above is based on the ideal calculation, and the loss caused by Lx switch and external components is not included.

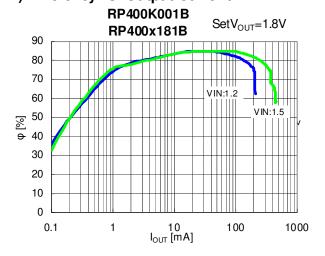
Please select the inductor and the diode with current peak to the standard (Formula 8).

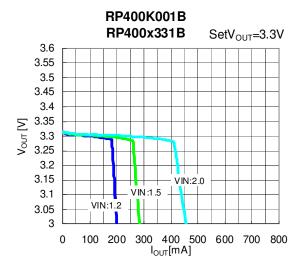
■ TYPICAL CHALACTERISTICS

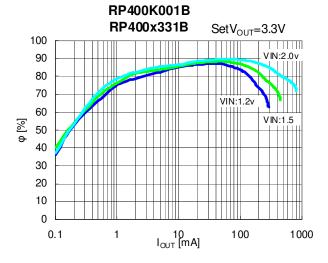
1) Output Voltage vs. Output Current

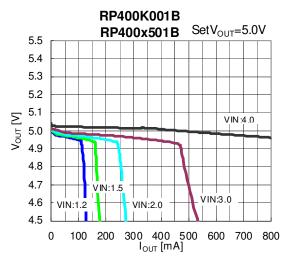


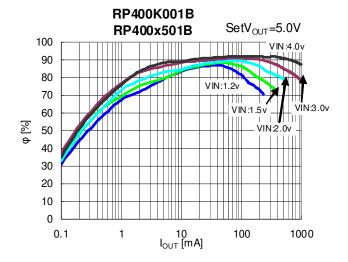
2) Efficiency vs. Output Current



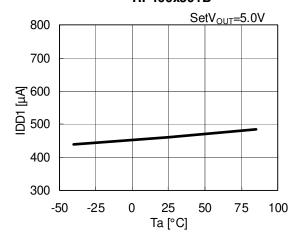




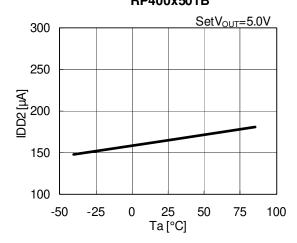




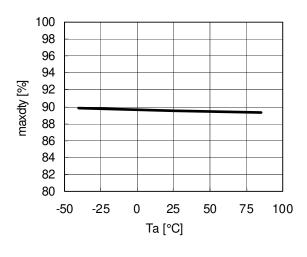
3) Quiescent Current 1 vs.Temperature RP400K001B RP400x501B



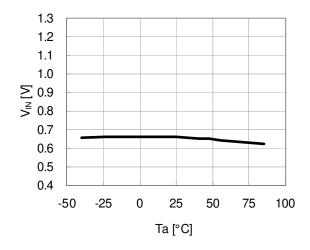
4) Quiescent Current 2 vs.Temperature RP400K001B RP400x501B



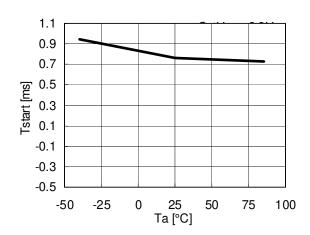
5) Maxduty vs. Temperature RP400K001B RP400xxx1B



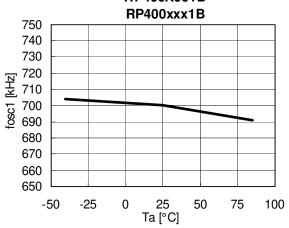
6) Start-up Voltage 2 vs. Temperature RP400K001B RP400xxx1B



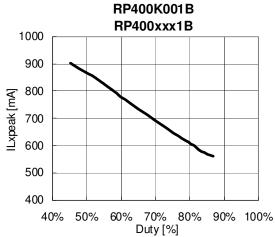
7) Soft-Start Period vs. Temperature RP400K001B RP400x331B



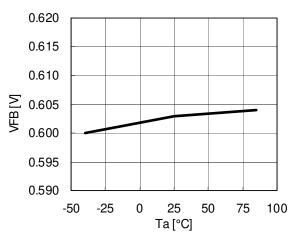
8) Switching Frequency vs. Temperature RP400K001B



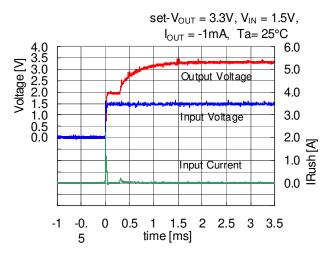
9) Lx Peak Current Limit vs. Duty



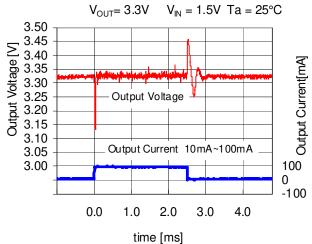
10) Feedback Voltage vs. Temperature RP400x001B



11) Start-up Waveform RP400K001B RP400x331B



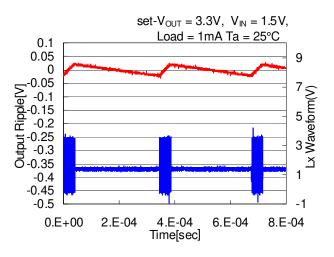
12) Load Response RP400K001B RP400x331B



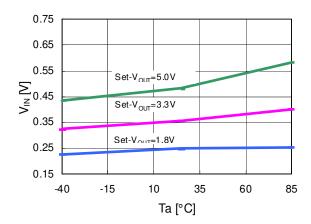
13) Output Voltage Waveform RP400K001B RP400x331B

set- $V_{OUT} = 3.3V$, $V_{IN} = 1.5V$ Load = 100mA Ta = 25°C 10 0.2 8 0 Output Ripple[V] 6 4 2 LX waveform(V) -0.2 -0.4 -0.6 0 -2 2.E-07 1.E-06 2.E-06 -8.E-07 3.E-06 Time[sec]

RP400K001B RP400x331B



14) Hold-on Voltage 1 RP400K001B RP400xxx1B





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- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
- 11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



Nisshinbo Micro Devices Inc.

Official website

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